



Data Sheet

Customer:	
Part No:	CL-SFD3535DBW-6K-C-01
Sample No:	
Description:	3535 White SMD
Item No:	

Customer							
Check	Check Inspection Approval Date						



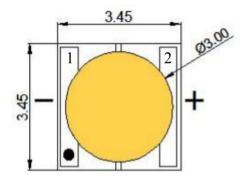


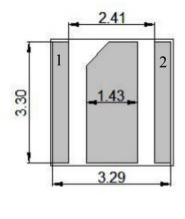
Features:

- . Reflow Solderable
- . High Luminous Intensity and Low Power Dissipation
- . Good Reliability and Long Life
- . Complied With RoHS Directive

Applications

- Optical indicator
- Indoor display
- Backlighting in dashboard and switch
- Flat backlighting for LCD, symbol and display
- General use



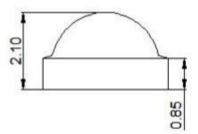


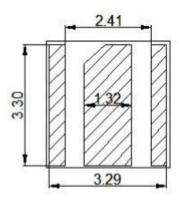




- 1. All dimension units are millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.











Selection Guide

Part No.	Chip	Lens Type .	Luminous flux(LM) @ 350mA			Viewing Angle
1 41 (1 (0,	Materials		Min	Тур	Max	201/2
CL-SFD3535DBW-6K-C-01	InGaN	Yellow Diffused	150		190	120

Note:

 $1.2\theta 1/2$ is the angle from optical centerline where the luminous intensity is $2\theta 1/2$ the optical centerline value.

2. The above luminous intensity measurement allowance tolerance $\pm 10\%$

Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Min.	Тур.	Max	Units	test conditions
Forward Voltage	VF	2.8		3.4	V	IF=350mA
Reverse Current	IR			10	uA	VR = 5V
Color Temperature	Tc		6000		K	IF=350mA

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Rating	Units
Power Dissipation	Pd	3400	mW
DC Forward Current	IF	1000	mA
Peak Forward Current [1]	IFP	2000	mA
Reverse Voltage	VR	5	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C

Note:

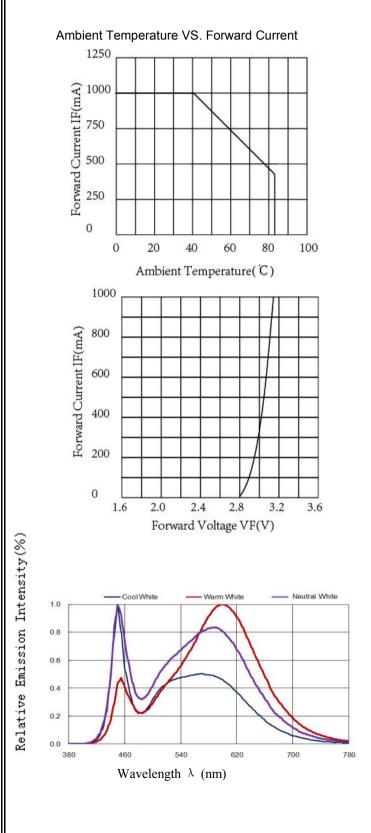
1. 1/10 Dut cycle,0.1ms pulse width.

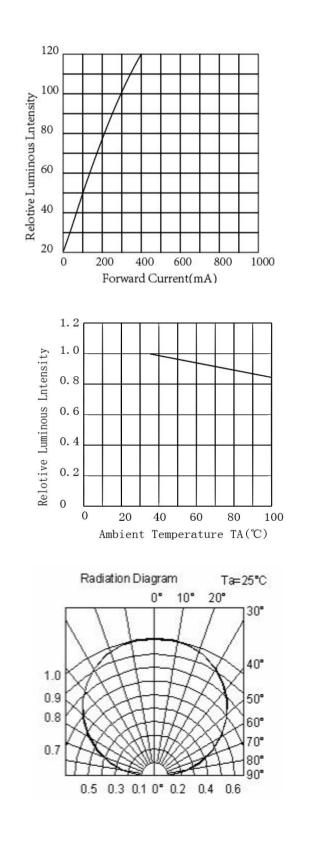
2. The above forward voltage measurement allowance tolerance $\pm 0.1 V$.





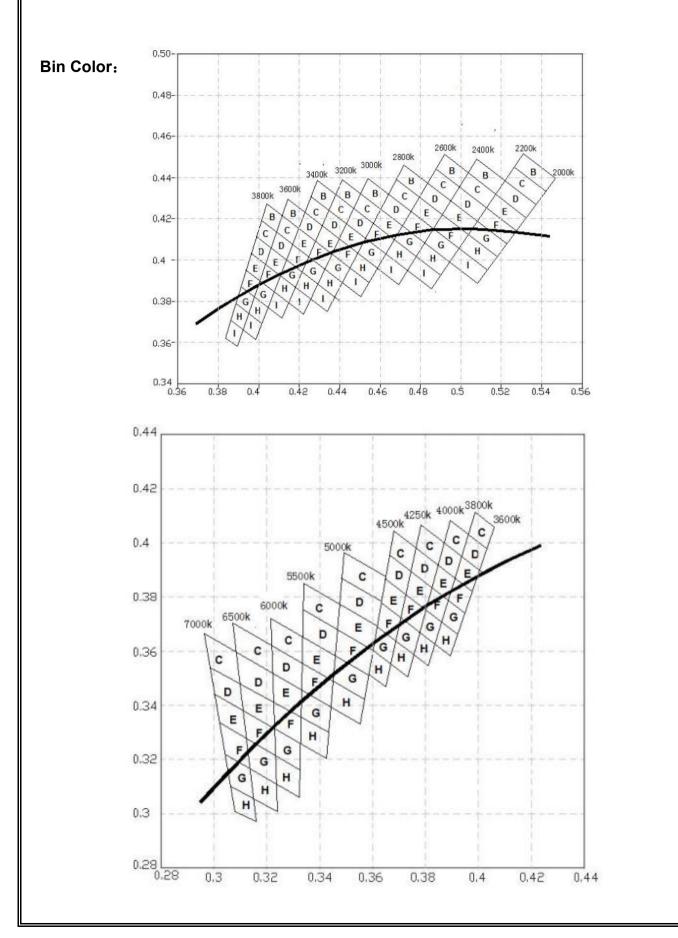
Typical optical characteristics curves











REV NO: A/1





Bin Color:

	0.5172	0.432		0.5127	0.4254		0.495	0.4287		0.4907	0.4219
20E	0.5324	0.4206	20F	0.5275	0.4142	22E	0.5082	0.4188	22F	0.5036	0.4122
2000-	0.5275	0.4142	2000-	0.5227 0.4078	2200-	0.5036	0.4122	2200-	0.4991	0.4057	
2200K	0.5127	0.4254	2200K	0.5082	0.4188	2400K	0.4907	0.4219	2400K	0.4865	0.4152
	0.4795	0.4304	1. marine	0.4753	0.4236	-	0.4605	0.4247	1000 M	0.4567	0.4176
24E	0.4907	0.4219	24F	0.4152	26E	0.4712	0.4167	26F	0.4671	0.4098	
2400-	0.4865	0.4152 2400- 0.4822 0.4084 2600-	2600-	0.4671	0.4098	2800-	0.463	0.4029			
2600K	0.4753	0.4236	2600K	0.4712	0.4167	2800K	0.4567	0.4176	2800K	0.4529	0.4105
2.22	0.4434	0.4176	0.2275	0.4399	0.4102		0.4315	0.4166		0.4281	0.4091
28E	0.4529	0.4105	28F 30E	0.4399	0.4102	30F	0.4364	0.4029			
2800-	0.4491	0.4033	2800-	0.4453	0.3962	3000-	0.4364	0.4029	3000-	0.4327	0.3951
3000K	0.4399	0.4102	3000K	0.4364	0.4029	3200K	200K 0.4281	0.4091	3200K	0.4248	0.4016
	0.4167	0.4077	a boul	0.4181	0.3867		0.4061	0.4057	(and the second	0.4033	0.3978
32E	0.4248	0.4016	32F	0.4106	0.3923	34E 0.4137 3400- 3600K 0.4106	0.4	34F	0.4106	0.3923	
3200-	0.4214	0.3942	3200- 3400K	0.4181	0.3867		0.4106	0.3923	3400- 3600K	0.4076	0.3846
3400K	0.4137	0.4	SHOOK	0.4106	0.3923	JOUUK	0.4033	0.3978		0.4006	0.3899
	0.3963	0.4031	- 36F - 3600-	0.3938	0.395	38E 3800- 4000K	0.3848	0.3918	38F 3800- 4000K	0.3825	0.3835
36E	0.4033	0.3978		0.4006	0.3899		0.3913	0.3869		0.3887	0.3788
3600- 3800K	0.4006	0.3899		0.3978	0.382		0.3887	0.3788		0.3862	0.3707
3000K	0.3938	0.395	3800K	0.3913	0.3869		0.3825	0.3835		0.3802	0.3752
40.00	0.3746	0.3895	107	0.3726	0.3809	1.000	0.3649	0.3868	42F 4250- 4500K	0.3633	0.3779
40E 4000-	0.3825	0.3835	40F	0.3804	0.3751	42E	0.3726	0.3809		0.3707	0.3724
4250K	0.3804	0.3751	4000- 4250K	0.378	0.3669	4250- 4500K	0.3707	0.3724		0.3688	0.3639
42.50K	0.3726	0.3809	445UK	0.3707	0.3724	ASAMUK	0.3633	0.3779	4.300TX	0.3618	0.3691
4000	0.3475	0.3775	400	0.3467	0.3679	-	0.3327	0.3659	FOR	0.3326	0.3559
45E	0.3618	0.3693	45F 4500-	0.3603	0.3602	50E 5000-	0.3459	0.3584	50F 5000-	0.345	0.3489
4500- 500.0K	0.3603	0.3602	5000K	0.3587	0.3511	5500K	0.345	0.3489	5500K	0.3442	0.3393
SOUTH	0.3467	0.3679	SUDDIK	0.3459	0.3584	-5,500 K	0.3326	0.3559	SOUTH	0.3325	0.3459
	0.3224	0.3517		0.3227	0.3415	100	0.3102	0.3486	COP	0.3117	0.3377
55E 5500-	0.3325	0.3459	55F	0.3325	0.336	60E 6000- 6500K	0.3227	0.3415	60F	0.323	0.3313
6000K	0.3325	0.3459	5500- 6000K	0.3324	0.326		0.323	0.3313	6000- 6500K	0.3234	0.3211
OUTUR	0.3227	0.3415	OUTUR	0.323	0.3313	0,000 K	0.3117	0.3377	USUOI	0.3133	0.3268
	0.3009	0.3438	in	0.3032	0.3325	7000	0.293	0.3383	705	0.2961	0.3265
65E	0.3117	0.3377	65F	0.3133	0.3268	70E	0.3032	0.3325	70F	0.3055	0.3212
6500- 7000K	0.3133	0.3268	6500- 7000K	0.3148	0.316	7000- 7500K	0.3055	0.3212	7000- 7500K	0.3078	0.3099
TOUR	0.3032	0.3325	7000K	0.3055	0.3212	TOUR	0.2961	0.3265	THUR	0.2992	0.3148





Reliability Test Items And Conditions

					-
Test Items	Ref.Standard	Test conditions	Time	Quantity	Ac/Re
Reflow Soldering	JESD22-B106	Temp.:260℃±5℃ Min.5sec.	3 times.	22Pcs.	0/1
Temperature Cycle	JESD22-A104	100°C±5°C 30 min. ↑↓5 min -40°C±5°C 30 min.	100 Cycles	22Pcs.	0/1
High Temperature Storage	JESD22-A103	Temp:100°C±5°C	1000Hrs	22Pcs.	0/1
Low Temperature Storage	JESD22-A119	Temp:-40 °C±5 °C	1000Hrs	22Pcs.	0/1
Life Test	JESD22-A108	Ta=25℃±5℃ IF=350mA	1000Hrs	22Pcs.	0/1
High temperature and high humidity storage experiment	JESD22-A101	85°C±5°C/85%RH	1000Hrs	22Pcs.	0/1

Criteria For Judging Damage

Test Items	Symbol	Test conditions	Criteria For Judgement	
			Min.	Max.
Forward Voltage	VF	IF=350mA		U.S.L*)x1.1
Reverse Current	IR	VR = 5V		U.S.L*)x2.0
Luminous intensity	IV	IF=350mA	L.S.L*)x0.7	

U.S.L: Upper standard level

L.S.L: Lower standard level

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

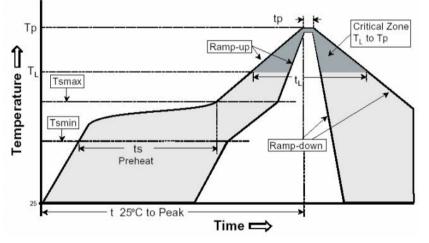




SMT Reflow Soldering Instructions

- 1. The number of reflow soldering shall not exceed two times, and the time from the second processing to the first completion shall not exceed 24H
- 2. When soldering , do not put stress on the LEDs during heating .
- 3.Reflow temperature distribution (Acc.to J-STD-020D)

Duefile Feeture	Sn-Pb Eutec	tic Assembly	Pb-Free Assembly			
Profile Feature	Large Body	Small Body	Large Body	Small Body		
Average ramp-up rate (TL to Tp)	3°C/seco	ond max.	3°C/second max.			
Preheat -Temperature Min(TSmin) -Temperature Max(TSmax) -Time(min to max)(ts)	150)°C)°C seconds	150℃ 200℃ 60-180 seconds			
Tsmax to TL -Ramp-up Rate			3°C/second max.			
Time maintained above: -Temperature(TL) -Time(t L)	183°C 60-150 seconds		217℃ 60-150 seconds			
Peak Temperature(Tp)	205+0/-5°C	220+0/-5°C	205+0/-5°C	220+0/-5°C		
Time within 5° of actual Peak Temperature(tp)	10-30 seconds	10-30 seconds	10-30 seconds 20-40 secor			
Ramp-down Rate	6°C/seco	ond max.	6°C/second max.			
Time 25°C to Peak Temperatur	6 minut	es max.	8 minutes max.			

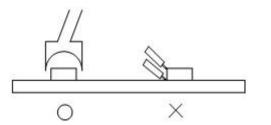


Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 350° C for 3 seconds
- 2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used(as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.







Storage

This product uses sealing anti-moisture antistatic packaging, and with desiccant, humidity card.

Before packaging is opened:

1 Storage environment: the ambient temperature should be kept between 5°C and 30°C, and the relative humidity should be kept within 60% RH. When the storage time of the product exceeds 3 months, it must be dehumidified before use. The dehumidification condition is: $65^{\circ}C/24H$.

 2_{∞} Please check that the package is leaking before opening. If it has leaked, please re-bake and use it or return to the plant to dehumidify.

After opening the package:

1. After opening the package, check whether the humidity card has a discoloration phenomenon. For example, 20 % of the humidity card indicates discoloration. Please remove the material from the bag and use it after dehumidifying 24H at 65 °C.

2. Environmental conditions: The ambient temperature should be kept between \leq 30 ° C and relative humidity The lower 60 % RH should be maintained.

 3_{\circ} if the material is not produced after exposure in the workshop for more than 24 hours, the product must be put back in the oven, dehumidified with 65 °C 24H, and then can be used again. If the material is not produced after 48 hours of exposure in the workshop, return the material to the SMD plant for high temperature dehumidification.

4. When the material is dehumidified, please do not open the oven in the middle, so that the oven temperature will not drop to the dehumidification effect.

Please refer to the following operating methods when the material needs to be dehumidified



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ESD

Static Electrisity will damage the LED.

The following steps can reduce the likelihood of ESD causing product damage

1.All productive machinery and test instruments must be electrically grounded.

2.Use a condustive wrist band or anti-electostatic glove when handling these LEDs.

3. Manintain a humidity level of 50% RHor higher in production areas.

4.Use anti-static packaging for transport and storage.

Handling Precautions

1.Do not stack the assembled PCB together. This may scratch the surface of the product or damage the circuit.



2.Not available in the situation of acidity for PH.



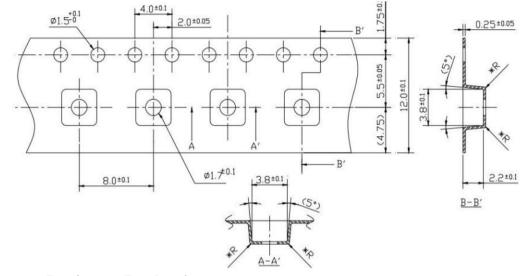
3.Electrostatic sensitive device



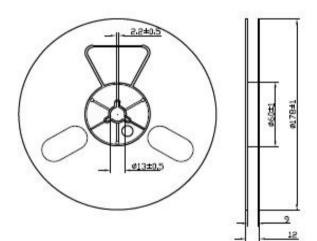




Carrier tape: 1000PCS/reel



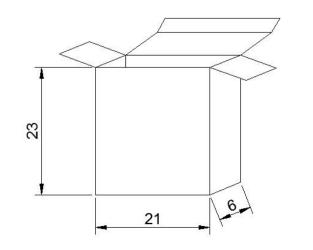
Moisture Resistant Packaging



Label

Cardboard Box

Maximum packing quantity (5 packs of material)



Maximum packing quantity (27 bags of material or 5 small boxes)

